Declaration, Power of Attorney and Petition

Page 1 of 3

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

claimed and fo	or which a patent	is sought on the inventio	n entitled		,				
SILANE P	OLYMER AND	METHOD FOR FORMI	NG SILICON FI	LM					
the specification	on of which								
	is attached h	iereto.							
	☐ was filed on	was filed on as							
	Application	Serial No.							
	and amende								
	was filed as	PCT international applica	ation						
	Number PCT/JP2004/008547								
	on June 11, 2004								
	and was am	ended under PCT Article	19						
	on	(if	applicable).						
		e (I) have reviewed and ed by any amendment ref		ents of the abov	e-identific	ed spe	cifica	tion,	
		uty to disclose informationitle 37 Code of Federal R		rial to the paten	tability of	this a	pplica	ation	
application(s) at least one co any foreign ap	for patent or involuntry other than oplication for pa	ign priority benefits un entor's certificate, or § 3 the United States, listed atent or inventor's certifin which priority is claime	65(a) of any PCT In below and have als icate, or PCT Intern	nternational app to identified bel national applica	lication wo	hich d ecking	esign	ated box,	
Applicati	on No.	Country	Day/M	onth/Year		Prio Clair			
No. 2003-169769		Japan	13/0	06/2003		Yes		No	
						Yes		No	
						Yes		No	
						Yes		No	

10/01

We (I) hereby claim the benefit under T application(s) listed below.	itle 35, United S	States Code, § 119(e) of any United States provisional						
(Application Number)	(Filing Date)							
(Application Number)		(Filing Date)						
We (I) hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or under § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.								
Application Serial No. Filing Date		Status (pending, patented, abandoned)						
And we (I) hereby appoint the following registered practitioner(s):								
22850								
as our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to								
	2285	 O						
We (I) declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.								
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